



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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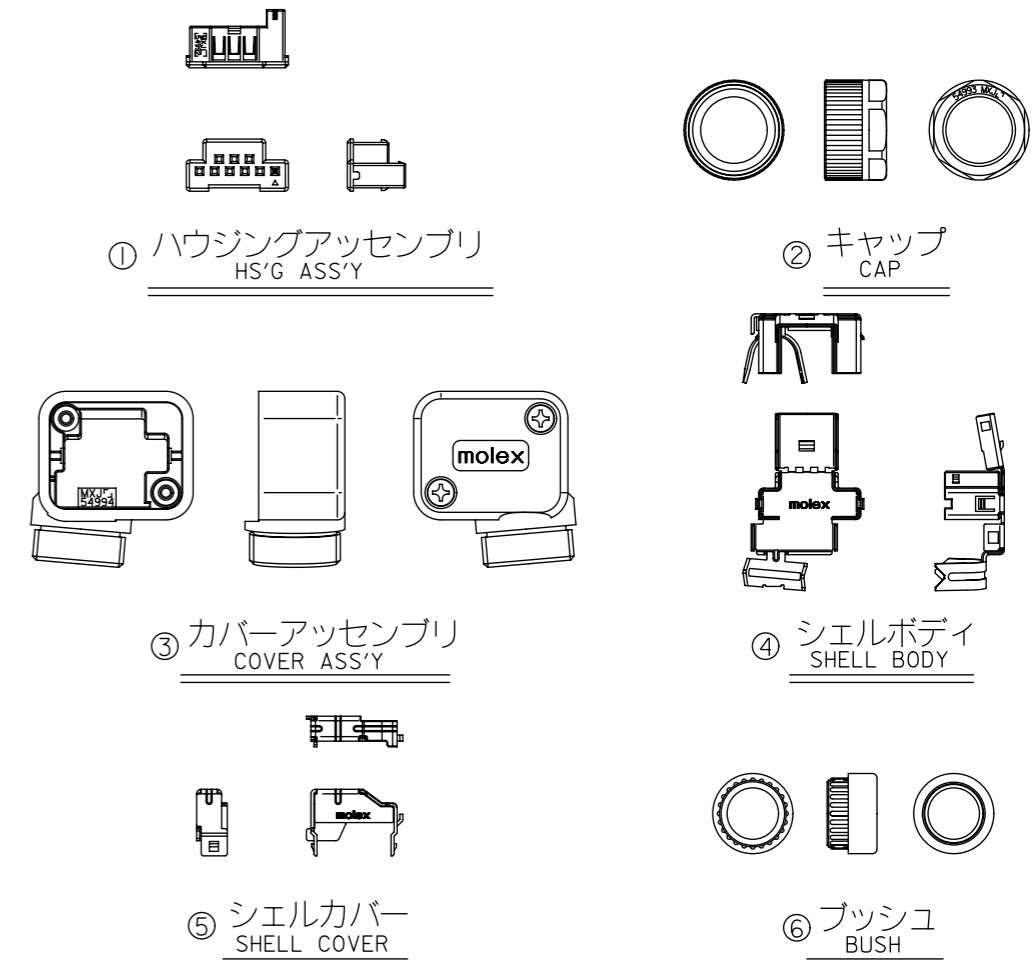
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部品構成 (詳細は、セールス図面を参照下さい)
PARTS CONSTRUCTION (REFER TO THE SALES DRAWING ON DETAIL)

部番 NO.	部品名 PART NAME	部品番号 PART NO.	個数 QUAN.	備考 NOTES
①	ハウジングアッセンブリ HS'G ASS'Y	54992-0929	1	材質 MATERIAL ハウジング: ガラス無しポリエステル (PBT) UL94V-0、黒色 HOUSING: GLASS NON-FILLED POLYESTER(PBT), UL94V-0, BLACK グランドコンタクト: りん青銅、t=0.152 GROUND CONTACT: PHOSPHOR BRONZE, t=0.152 メッキ仕様 PLATING SPECIFICATION 接点部: 金メッキ 0.1μm MIN. CONTACT: GOLD PLATING 0.1μm MIN. 下地: ニッケルメッキ 1.5μm MIN. UNDER PLATING: NICKEL PLATING 1.5μm MIN.
②	キャップ CAP	54993-0001	1	材質: ガラス入りポリエステル(PBT)、UL94V-0、黒色 MATERIAL: GLASS FILLED POLYESTER(PBT), UL94V-0, BLACK
③	カバーアッセンブリ COVER ASS'Y	54994-0011	1	材質 MATERIAL ハウジング: ガラス入りポリエステル(PBT)、UL94V-0、黒色 HOUSING: GLASS FILLED POLYESTER(PBT), UL94V-0, BLACK M2ネジ: 鋼材、ニッケルメッキ M2 SCREW: STEEL, NICKEL PLATING O-リング: シリコンゴム O-RING: SILICON RUBBER
④	シェルボディ SHELL BODY	56492-0028	1	材質: りん青銅、t=0.4 MATERIAL: PHOSPHOR BRONZE, t=0.4 メッキ仕様 PLATING 錫メッキ: 3μm MIN. TIN: 3μm MIN. ニッケルメッキ: 1.0μm MIN. (下地メッキ) NICKEL: 1.0μm MIN. (UNDER PLATING)
⑤	シェルカバー SHELL COVER	56493-0000	1	材質: ステンレス、t=0.4 MATERIAL: STAINLESS, t=0.4
⑥	ブッシュ BUSH	56496-0000	1	材質: シリコンゴム、黄色 MATERIAL: SILICON RUBBER, YELLOW 適用ケーブル外径: φ6.5~φ7.7 CABLE SIZE: φ6.5~φ7.7
		56496-0001		材質: シリコンゴム、青色 MATERIAL: SILICON RUBBER, BLUE 適用ケーブル外径: φ6.3~φ7 CABLE SIZE: φ6.3~φ7



54992-0929	54993-0001	54994-0011	56492-0028	56493-0000	56496-0001	54346-0071
					56496-0000	54346-0070
ハウジングアッセンブリ HS'G ASS'Y	キャップ CAP	カバーアッセンブリ COVER ASS'Y	シェルボディ SHELL BODY	シェルカバー SHELL COVER	ブッシュ BUSH	キット番号 KIT NO.

注記
NOTES

- 組立方法は、アプリケーション仕様書 AS-54992-006 参照のこと。
METHOD OF ASSEMBLY REFER TO APPLICATION SPECIFICATION AS-54992-006.
- 適合クリンプリセプタクル 56161-8*** は別売りとなります。
(詳細は、セールス図面を参照下さい。)
APPLICABLE CRIMP RECEPTACLE BECOMES ANOTHER SALES.
(REFER TO THE SALES DRAWING ON DETAIL)
- 本製品は 54346-002* の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 54346-002*

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

REDRAWN AND REVISED		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION UNITS		SCALE			
2017/06/12	DRWN: QHE31	ANGULAR TOL ± °		MM	1:1				
2017/07/10	CHK'D: SAKIYAMA	4 PLACES ±		DRWN BY	DATE				
2017/07/10	APPR: TKANEKO	3 PLACES ±		QHE31	2017/06/12				
		2 PLACES ±		CHK'D BY	DATE				
		1 PLACE ±		SAKIYAMA	2017/07/10				
		0 PLACES ±		APPR BY	DATE				
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		TKANEKO	2017/07/10				
EC NO: 118112				DRAWING SIZE	THIRD ANGLE PROJECTION		PRODUCT CUSTOMER DRAWING		
A	REV			A3			SERIES	MATERIAL NUMBER	CUSTOMER
							54346	SEE CHART	GENERAL
							DOCUMENT NUMBER		DOC TYPE
							543460070		PSD
							DOC PART	SHEET NUMBER	
							001	1 OF 1	